

Claims:

1. A liquid curing resin composition comprising the following components (A) and (B):

(A) 30 to 70 wt.% of a urethane (meth)acrylate having a number-average molecular weight of from 10000 to 40000, and

(B) 30 to 60 wt.% of an ethylenically unsaturated monomer having a glass transition point, in the form of a homopolymer, of 60°C or greater.

2. The liquid curing resin composition of Claim 1, further comprising γ -mercaptopropyltrimethoxysilane.

3. The liquid curing resin composition of Claim 1 or 2, wherein the component (B) contains at least one compound selected from the group consisting of acryloylmorpholine, dimethylacrylamide, N-vinylpyrrolidone and N-vinylcaprolactam.

4. The liquid curing resin composition of any one of Claims 1 to 3, which is suited for use as an adhesive.